

## 5MHz, Low-Noise, Single, Dual, Quad CMOS Operational Amplifiers

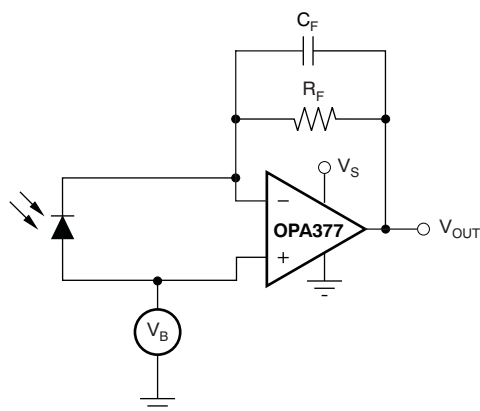
Check for Samples: [OPA377](#), [OPA2377](#), [OPA4377](#)

### FEATURES

- **GAIN BANDWIDTH PRODUCT: 5.5MHz**
- **LOW NOISE: 7.5nV/ $\sqrt{\text{Hz}}$  at 1kHz**
- **OFFSET VOLTAGE: 1mV (max)**
- **INPUT BIAS CURRENT: 0.2pA**
- **RAIL-TO-RAIL OUTPUT**
- **UNITY-GAIN STABLE**
- **EMI INPUT FILTERING**
- **QUIESCENT CURRENT: 0.76mA/ch**
- **SUPPLY VOLTAGE: 2.2V to 5.5V**
- **SMALL PACKAGES:**  
SC70, SOT23, and MSOP

### APPLICATIONS

- **PHOTODIODE PREAMP**
- **PIEZOELECTRIC SENSOR PREAMP**
- **SENSOR SIGNAL CONDITIONING**
- **AUDIO EQUIPMENT**
- **ACTIVE FILTERS**



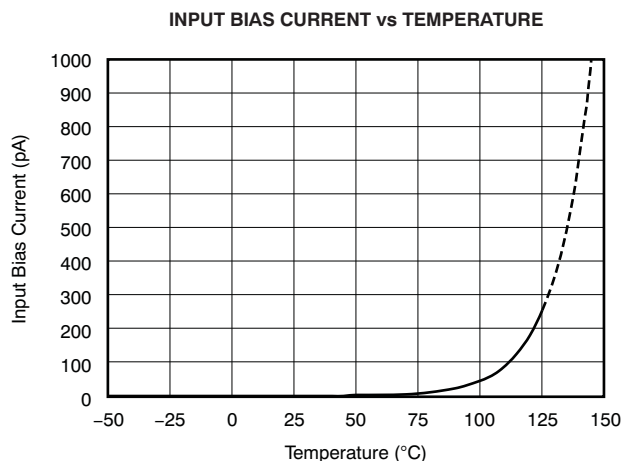
Photodiode Preamplifier

### DESCRIPTION

The OPA377 family of operational amplifiers are wide-bandwidth CMOS amplifiers that provide very low noise, low input bias current, and low offset voltage while operating on a low quiescent current of 0.76mA (typ).

The OPA377 op amps are optimized for low-voltage, single-supply applications. The exceptional combination of ac and dc performance make them ideal for a wide range of applications, including small signal conditioning, audio, and active filters. In addition, these parts have a wide supply range with excellent PSRR, making them attractive for applications that run directly from batteries without regulation.

The OPA377 is available in the SC70-5, SOT23-5, and SO-8 packages. The dual OPA2377 is offered in the SO-8 and MSOP-8, and the quad OPA4377 in the TSSOP-14 packages. All versions are specified for operation from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ABSOLUTE MAXIMUM RATING<sup>(1)</sup>

Over operating free-air temperature range, unless otherwise noted.

|                                     |                        | OPA377, OPA2377, OPA4377     | UNIT |
|-------------------------------------|------------------------|------------------------------|------|
| Supply Voltage $V_S = (V+) - (V-)$  |                        | +7                           | V    |
| Signal Input Terminals              | Voltage <sup>(2)</sup> | $(V-) - 0.5$ to $(V+) + 0.5$ | V    |
|                                     | Current <sup>(2)</sup> | ±10                          | mA   |
| Output Short-Circuit <sup>(3)</sup> |                        | Continuous                   |      |
| Operating Temperature               | $T_A$                  | –40 to +150                  | °C   |
| Storage Temperature                 | $T_A$                  | –65 to +150                  | °C   |
| Junction Temperature                | $T_J$                  | +150                         | °C   |
| ESD Rating                          | Human Body Model       | 4000                         | V    |
|                                     | Charged Device Model   | 1000                         | V    |
|                                     | Machine Model          | 200                          | V    |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not supported.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current limited to 10mA or less.
- (3) Short-circuit to ground, one amplifier per package.

## PACKAGE INFORMATION<sup>(1)</sup>

| PRODUCT | PACKAGE-LEAD | PACKAGE DESIGNATOR | PACKAGE MARKING |
|---------|--------------|--------------------|-----------------|
| OPA377  | SC70-5       | DCK                | OP377A          |
|         | SOT23-5      | DBV                | OP377A          |
|         | SO-8         | D                  | OP377A          |
| OPA2377 | SO-8         | D                  | O2377A          |
|         | MSOP-8       | DGK                | OTAQ            |
| OPA4377 | TSSOP-14     | PW                 | O4377A          |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at [www.ti.com](http://www.ti.com).

## ELECTRICAL CHARACTERISTICS: $V_S = +2.2V$ to $+5.5V$

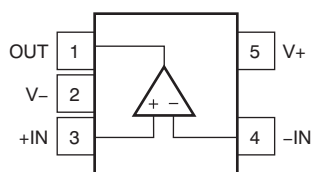
**Boldface** limits apply over the specified temperature range:  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ .

At  $T_A = +25^{\circ}C$ ,  $R_L = 10k\Omega$  connected to  $V_S/2$ ,  $V_{CM} = V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.

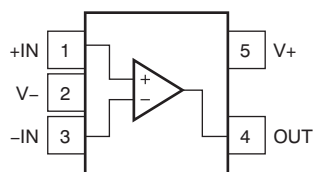
| PARAMETERS                          |                      | CONDITIONS                                                                   | OPA377, OPA2377, OPA4377                    |         |            | UNIT             |
|-------------------------------------|----------------------|------------------------------------------------------------------------------|---------------------------------------------|---------|------------|------------------|
|                                     |                      |                                                                              | MIN                                         | TYP     | MAX        |                  |
| OFFSET VOLTAGE                      |                      |                                                                              |                                             |         |            |                  |
| Input Offset Voltage                | V <sub>OS</sub>      | V <sub>S</sub> = +5V                                                         |                                             | 0.25    | 1          | mV               |
| vs Temperature                      | dV <sub>OS</sub> /dT | −40°C to +125°C                                                              |                                             | 0.32    | 2          | μV/°C            |
| vs Power Supply                     | PSRR                 | V <sub>S</sub> = +2.2V to +5.5V, V <sub>CM</sub> < (V+) − 1.3V               |                                             | 5       | 28         | μV/V             |
| Over Temperature                    |                      | V <sub>S</sub> = +2.2V to +5.5V, V <sub>CM</sub> < (V+) − 1.3V               |                                             | 5       |            | μV/V             |
| Channel Separation, dc (dual, quad) |                      |                                                                              |                                             | 0.5     |            | μV/V             |
| INPUT BIAS CURRENT                  |                      |                                                                              |                                             |         |            |                  |
| Input Bias Current                  | I <sub>B</sub>       |                                                                              |                                             | ±0.2    | ±10        | pA               |
| Over Temperature                    |                      |                                                                              | See <a href="#">Typical Characteristics</a> |         |            | pA               |
| Input Offset Current                | I <sub>OS</sub>      |                                                                              |                                             | ±0.2    | ±10        | pA               |
| NOISE                               |                      |                                                                              |                                             |         |            |                  |
| Input Voltage Noise,                | e <sub>n</sub>       | f = 0.1Hz to 10Hz                                                            |                                             | 0.8     |            | μV <sub>PP</sub> |
| Input Voltage Noise Density         | e <sub>n</sub>       | f = 1kHz                                                                     |                                             | 7.5     |            | nV/√Hz           |
| Input Current Noise                 | i <sub>n</sub>       | f = 1kHz                                                                     |                                             | 2       |            | fA/√Hz           |
| INPUT VOLTAGE RANGE                 |                      |                                                                              |                                             |         |            |                  |
| Common-Mode Voltage Range           | V <sub>CM</sub>      |                                                                              | (V−) − 0.1                                  |         | (V+) + 0.1 | V                |
| Common-Mode Rejection Ratio         | CMRR                 | (V−) < V <sub>CM</sub> < (V+) − 1.3 V                                        | 70                                          | 90      |            | dB               |
| INPUT CAPACITANCE                   |                      |                                                                              |                                             |         |            |                  |
| Differential                        |                      |                                                                              |                                             | 6.5     |            | pF               |
| Common-Mode                         |                      |                                                                              |                                             | 13      |            | pF               |
| OPEN-LOOP GAIN                      |                      |                                                                              |                                             |         |            |                  |
| Open-Loop Voltage Gain              | A <sub>OL</sub>      | 50mV < V <sub>O</sub> < (V+) − 50mV, R <sub>L</sub> = 10kΩ                   | 112                                         | 134     |            | dB               |
|                                     |                      | 100mV < V <sub>O</sub> < (V+) − 100mV, R <sub>L</sub> = 2kΩ                  |                                             | 126     |            | dB               |
| FREQUENCY RESPONSE                  |                      | V <sub>S</sub> = 5.5V                                                        |                                             |         |            |                  |
| Gain-Bandwidth Product              | GBW                  |                                                                              |                                             | 5.5     |            | MHz              |
| Slew Rate                           | SR                   | G = +1                                                                       |                                             | 2       |            | V/μs             |
| Settling Time 0.1%                  | t <sub>S</sub>       | 2V Step , G = +1                                                             |                                             | 1.6     |            | μs               |
| Settling Time 0.01%                 | t <sub>S</sub>       | 2V Step , G = +1                                                             |                                             | 2       |            | μs               |
| Overload Recovery Time              |                      | V <sub>IN</sub> × Gain > V <sub>S</sub>                                      |                                             | 0.33    |            | μs               |
| THD + Noise                         | THD+N                | V <sub>O</sub> = 1V <sub>RMS</sub> , G = +1, f = 1kHz, R <sub>L</sub> = 10kΩ |                                             | 0.00027 |            | %                |
| OUTPUT                              |                      |                                                                              |                                             |         |            |                  |
| Voltage Output Swing from Rail      |                      | R <sub>L</sub> = 10kΩ                                                        |                                             | 10      | 20         | mV               |
| Over Temperature                    |                      | R <sub>L</sub> = 10kΩ                                                        |                                             |         | 40         | mV               |
| Short-Circuit Current               | I <sub>SC</sub>      |                                                                              |                                             | +30/−50 |            | mA               |
| Capacitive Load Drive               | C <sub>LOAD</sub>    |                                                                              | See <a href="#">Typical Characteristics</a> |         |            |                  |
| Open-Loop Output Impedance          |                      | R <sub>O</sub>                                                               |                                             | 150     |            | Ω                |
| POWER SUPPLY                        |                      |                                                                              |                                             |         |            |                  |
| Specified Voltage Range             | V <sub>S</sub>       |                                                                              | 2.2                                         |         | 5.5        | V                |
| Quiescent Current per amplifier     | I <sub>Q</sub>       | I <sub>O</sub> = 0, V <sub>S</sub> = +5.5V                                   |                                             | 0.76    | 1.05       | mA               |
| Over Temperature                    |                      |                                                                              |                                             |         | 1.2        | mA               |
| TEMPERATURE RANGE                   |                      |                                                                              |                                             |         |            |                  |
| Specified Range                     |                      |                                                                              | −40                                         |         | +125       | °C               |
| Thermal Resistance                  | θ <sub>JA</sub>      |                                                                              |                                             |         |            | °C/W             |
| SC70-5                              |                      |                                                                              |                                             | 250     |            | °C/W             |
| SOT23-5                             |                      |                                                                              |                                             | 200     |            | °C/W             |
| MSOP-8, SO-8, TSSOP-14              |                      |                                                                              |                                             | 150     |            | °C/W             |

## PIN CONFIGURATIONS

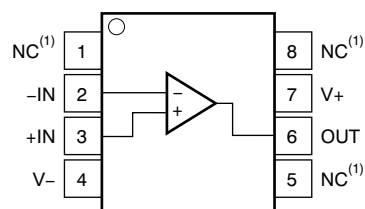
**OPA377  
SOT23-5  
(TOP VIEW)**



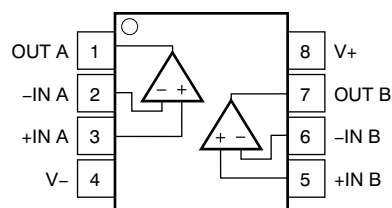
**OPA377  
SC70-5  
(TOP VIEW)**



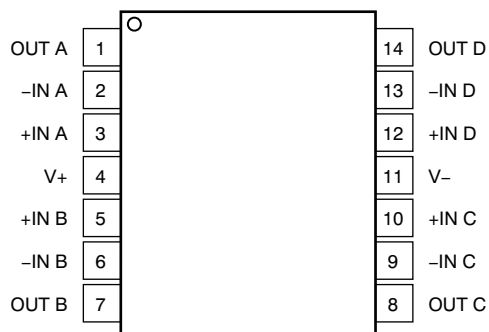
**OPA377  
SO-8  
(TOP VIEW)**



**OPA2377  
SO-8, MSOP-8  
(TOP VIEW)**



**OPA4377  
TSSOP-14  
(TOP VIEW)**



(1) NC denotes no internal connection.

(2) Connect thermal die to V-.

## TYPICAL CHARACTERISTICS

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{CM} = V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.

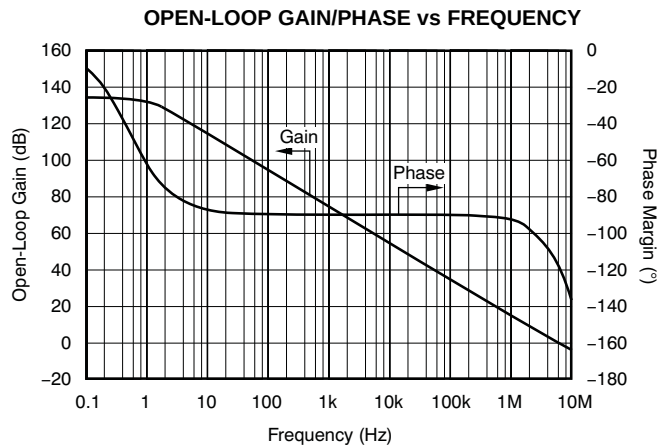


Figure 1.

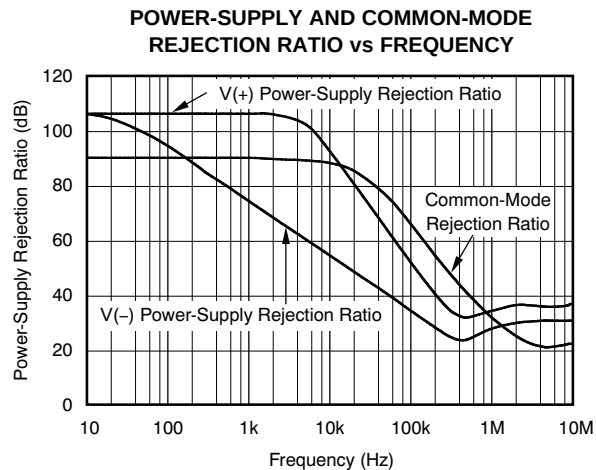


Figure 2.

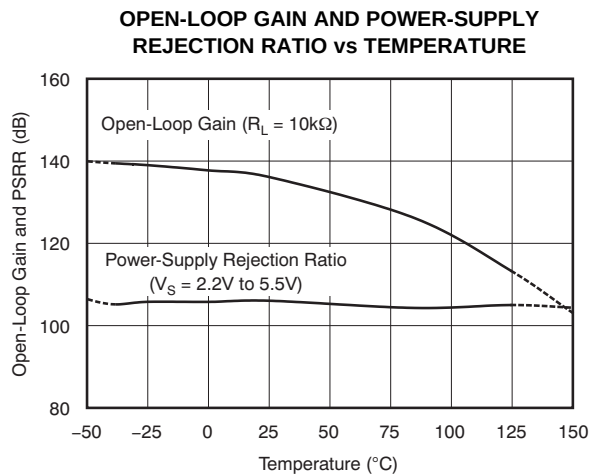


Figure 3.

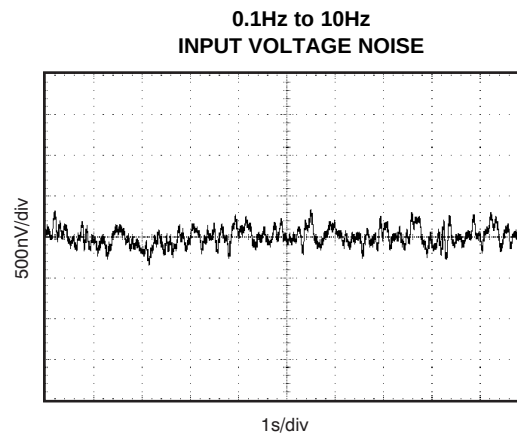


Figure 4.

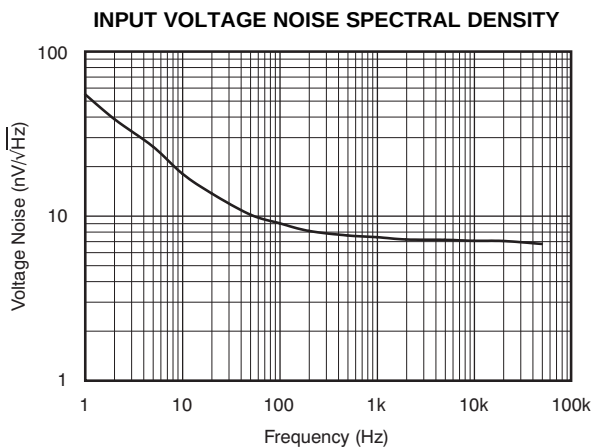


Figure 5.

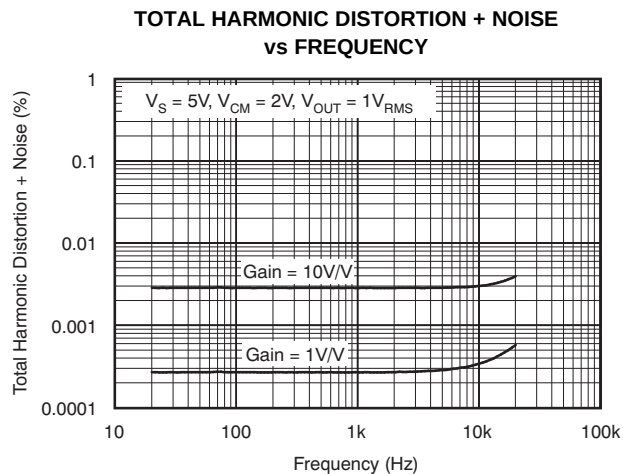


Figure 6.

## TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{CM} = V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.

**COMMON-MODE REJECTION RATIO  
vs TEMPERATURE**

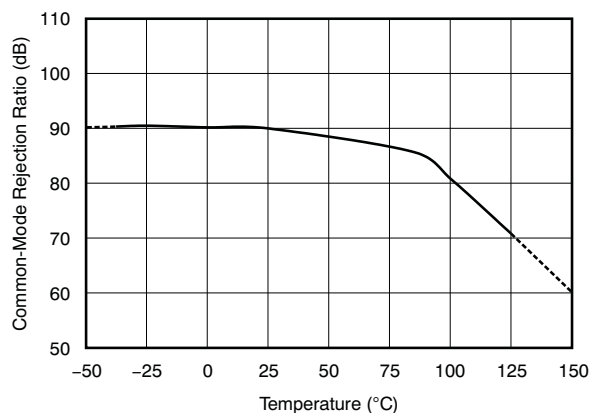


Figure 7.

**QUIESCENT CURRENT  
vs TEMPERATURE**

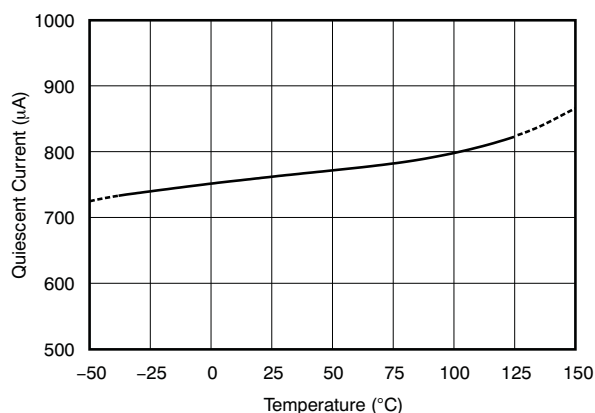


Figure 8.

**QUIESCENT AND SHORT-CIRCUIT CURRENT  
vs SUPPLY VOLTAGE**

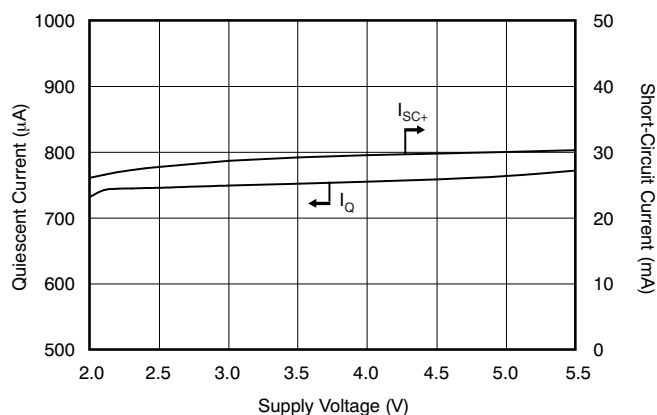


Figure 9.

**SHORT-CIRCUIT CURRENT  
vs TEMPERATURE**

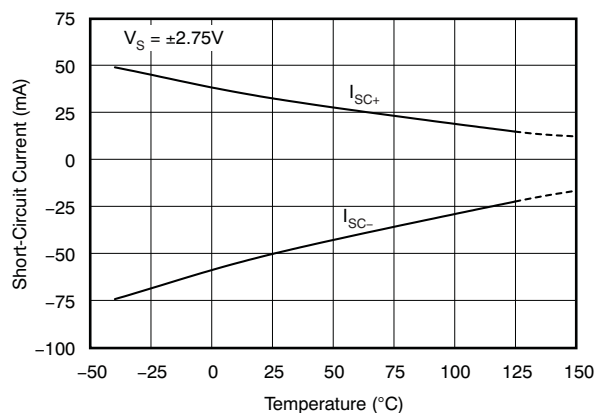


Figure 10.

**INPUT BIAS CURRENT vs TEMPERATURE**

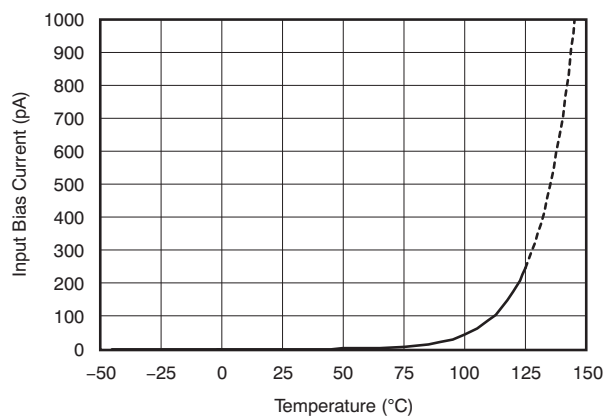


Figure 11.

**OUTPUT VOLTAGE vs OUTPUT CURRENT**

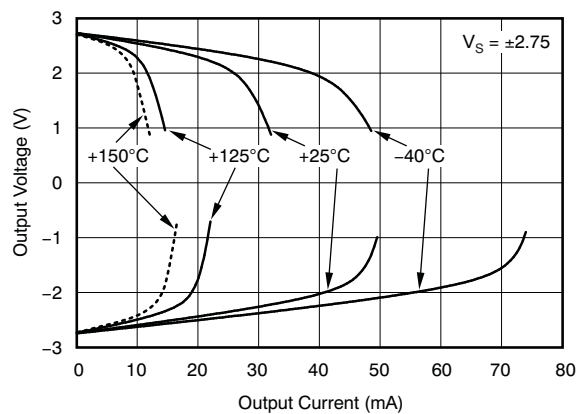


Figure 12.

## TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{CM} = V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.

**OFFSET VOLTAGE  
PRODUCTION DISTRIBUTION**

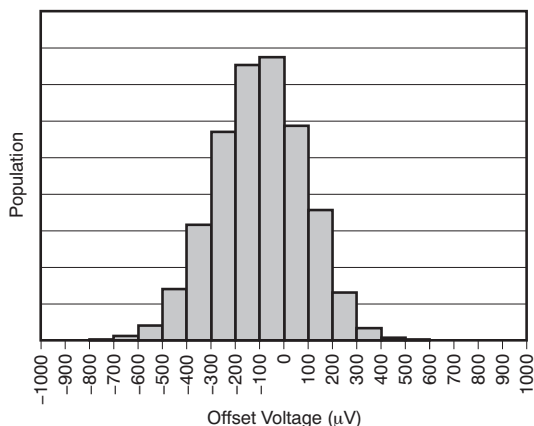


Figure 13.

**MAXIMUM OUTPUT VOLTAGE vs FREQUENCY**

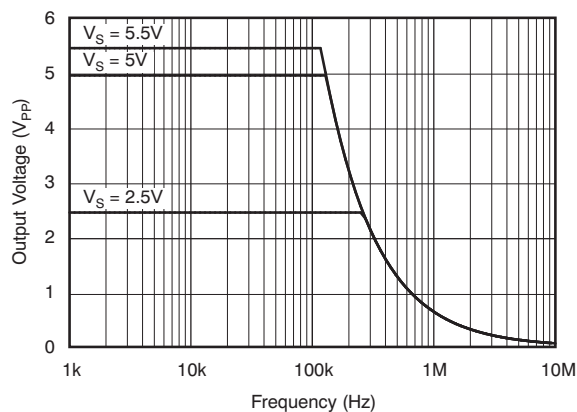


Figure 14.

**SMALL-SIGNAL OVERSHOOT vs LOAD CAPACITANCE**

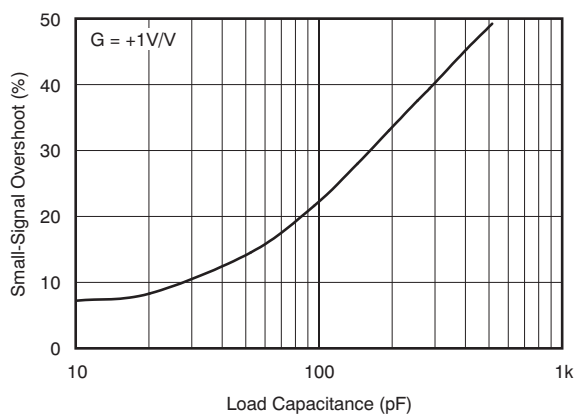


Figure 15.

**SMALL-SIGNAL PULSE RESPONSE**

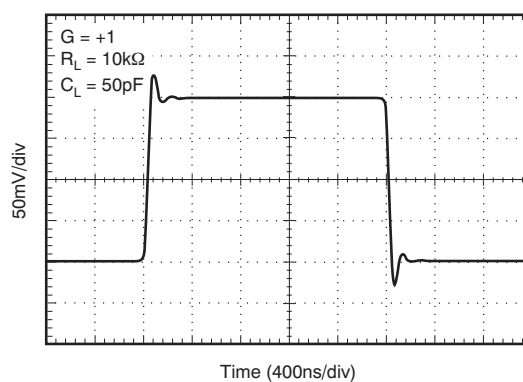


Figure 16.

**LARGE-SIGNAL PULSE RESPONSE**

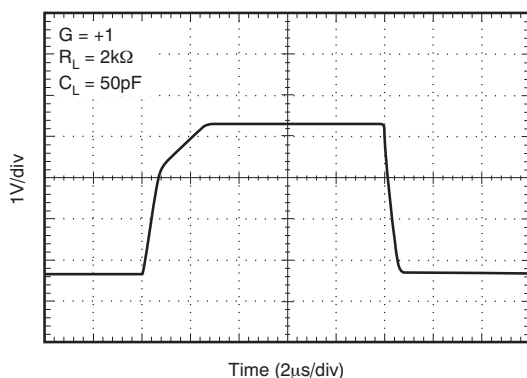


Figure 17.

**SETTLING TIME vs CLOSED-LOOP GAIN**

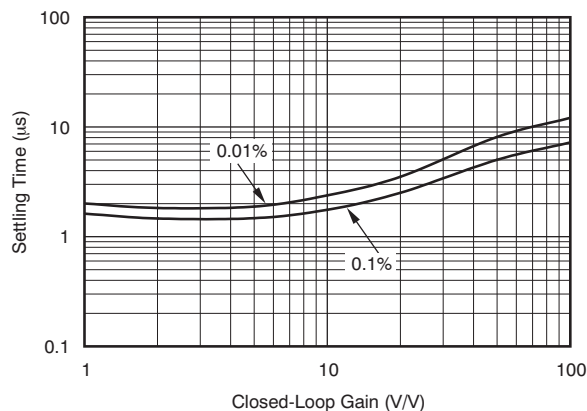


Figure 18.

## TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = +5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{CM} = V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.

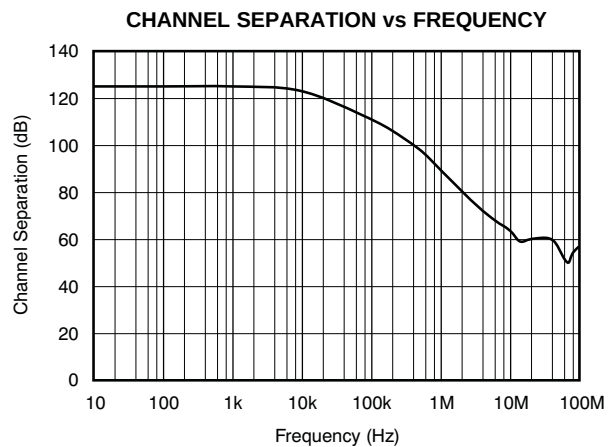


Figure 19.

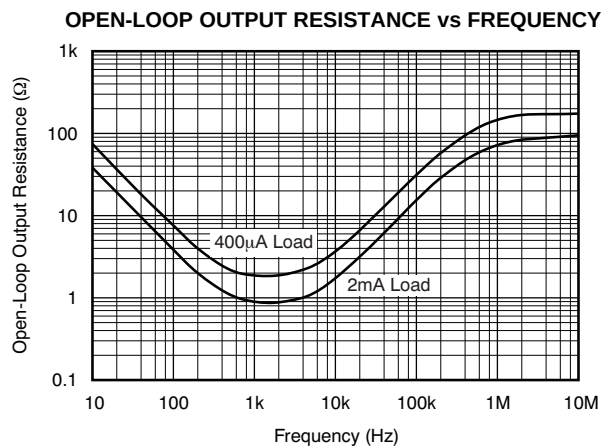


Figure 20.

## APPLICATION INFORMATION

### OPERATING CHARACTERISTICS

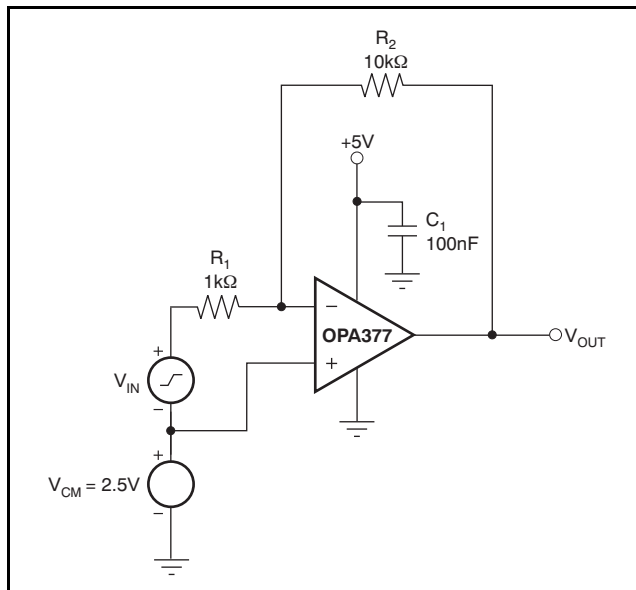
The OPA377 family of amplifiers has parameters that are fully specified from 2.2V to 5.5V ( $\pm 1.1V$  to  $\pm 2.75V$ ). Many of the specifications apply from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . Parameters that can exhibit significant variance with regard to operating voltage or temperature are presented in the [Typical Characteristics](#).

### GENERAL LAYOUT GUIDELINES

For best operational performance of the device, good printed circuit board (PCB) layout practices are required. Low-loss,  $0.1\mu\text{F}$  bypass capacitors must be connected between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from  $V+$  to ground is applicable to single-supply applications.

### BASIC AMPLIFIER CONFIGURATIONS

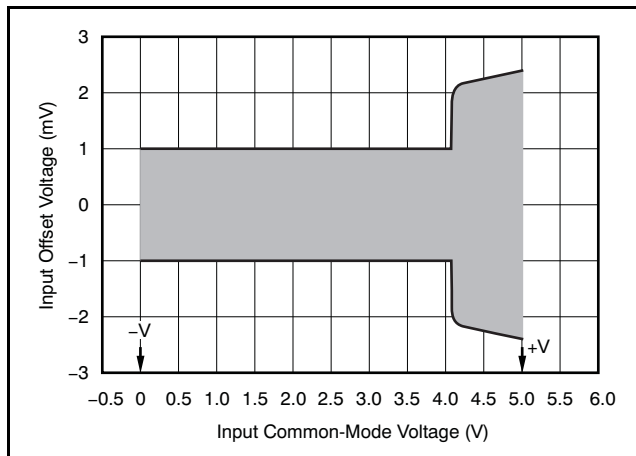
The OPA377 family is unity-gain stable. It does not exhibit output phase inversion when the input is overdriven. A typical single-supply connection is shown in [Figure 21](#). The OPA377 is configured as a basic inverting amplifier with a gain of  $-10V/V$ . This single-supply connection has an output centered on the common-mode voltage,  $V_{CM}$ . For the circuit shown, this voltage is 2.5V, but may be any value within the common-mode input voltage range.



**Figure 21. Basic Single-Supply Connection**

### COMMON-MODE VOLTAGE RANGE

The input common-mode voltage range of the OPA377 series extends 100mV beyond the supply rails. The offset voltage of the amplifier is low, from approximately  $(V-)$  to  $(V+) - 1V$ , as shown in [Figure 22](#). The offset voltage increases as common-mode voltage exceeds  $(V+) - 1V$ . Common-mode rejection is specified from  $(V-)$  to  $(V+) - 1.3V$ .



**Figure 22. Offset and Common-Mode Voltage**

## INPUT AND ESD PROTECTION

The OPA377 family incorporates internal electrostatic discharge (ESD) protection circuits on all pins. In the case of input and output pins, this protection primarily consists of current steering diodes connected between the input and power-supply pins. These ESD protection diodes also provide in-circuit, input overdrive protection, as long as the current is limited to 10mA as stated in the [Absolute Maximum Ratings](#). [Figure 23](#) shows how a series input resistor may be added to the driven input to limit the input current. The added resistor contributes thermal noise at the amplifier input and its value should be kept to a minimum in noise-sensitive applications.

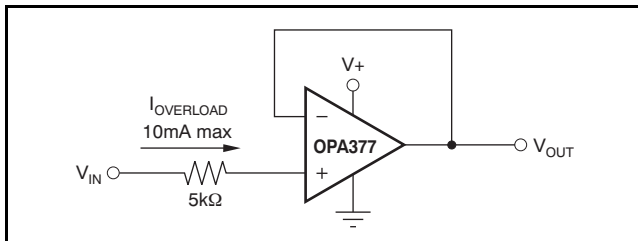


Figure 23. Input Current Protection

## EMI SUSCEPTIBILITY AND INPUT FILTERING

Operational amplifiers vary in susceptibility to electromagnetic interference (EMI). If conducted EMI enters the operational amplifier, the dc offset observed at the amplifier output may shift from the nominal value while the EMI is present. This shift is a result of signal rectification associated with the internal semiconductor junctions. While all amplifier pin functions can be affected by EMI, the input pins are likely to be the most susceptible. The OPA377 operational amplifier family incorporates an internal input low-pass filter that reduces the amplifier response to EMI. Both common-mode and differential mode filtering are provided by the input filter. The filter is designed for a cutoff frequency of approximately 75MHz (–3dB), with a roll-off of 20dB per decade.

## CAPACITIVE LOAD AND STABILITY

The OPA377 series of amplifiers may be used in applications where driving a capacitive load is required. As with all op amps, there may be specific instances where the OPAX377 can become unstable, leading to oscillation. The particular op amp circuit configuration, layout, gain, and output loading are some of the factors to consider when establishing whether an amplifier will be stable in operation. An op amp in the unity-gain (+1V/V) buffer configuration and driving a capacitive load exhibits a greater tendency to be unstable than an amplifier operated at a higher noise gain. The capacitive load, in conjunction with the op amp output resistance, creates a pole within the feedback loop that degrades the phase margin. The degradation of the phase margin increases as the capacitive loading increases.

The OPAX377 in a unity-gain configuration can directly drive up to 250pF pure capacitive load. Increasing the gain enhances the ability of the amplifier to drive greater capacitive loads; see the typical characteristic plot, [Small-Signal Overshoot vs Capacitive Load](#). In unity-gain configurations, capacitive load drive can be improved by inserting a small (10Ω to 20Ω) resistor,  $R_S$ , in series with the output, as shown in [Figure 24](#). This resistor significantly reduces ringing while maintaining dc performance for purely capacitive loads. However, if there is a resistive load in parallel with the capacitive load, a voltage divider is created, introducing a gain error at the output and slightly reducing the output swing. The error introduced is proportional to the ratio  $R_S/R_L$ , and is generally negligible at low output current levels.

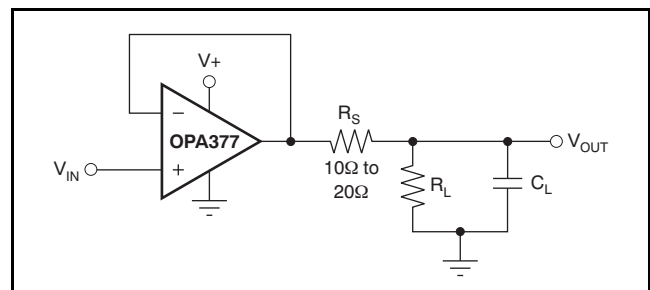
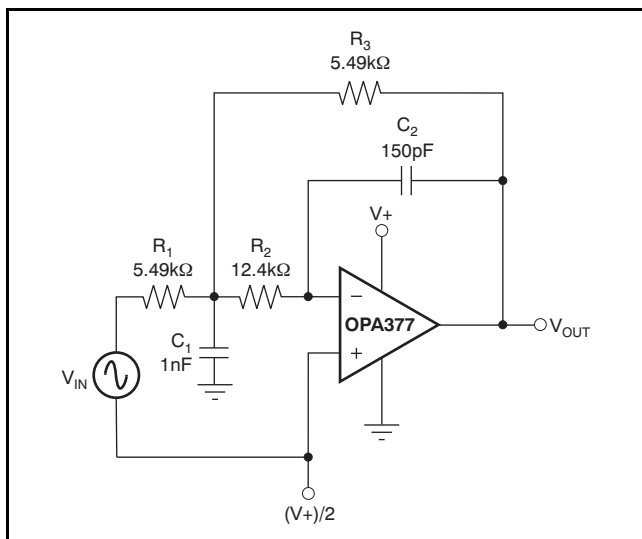


Figure 24. Improving Capacitive Load Drive

## ACTIVE FILTERING

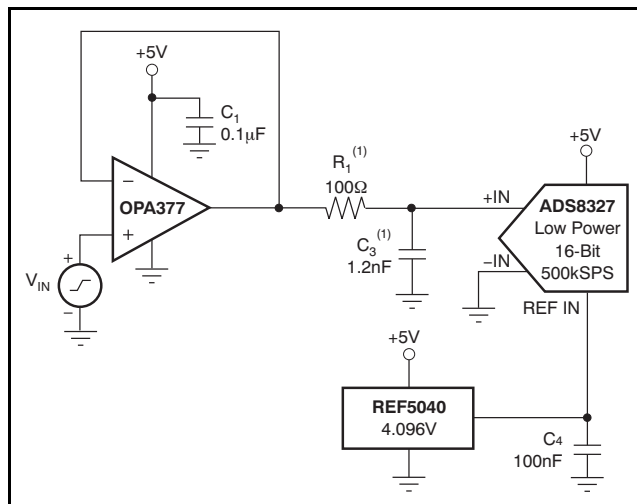
The OPA377 series is well-suited for filter applications requiring a wide bandwidth, fast slew rate, low-noise, single-supply operational amplifier. Figure 25 shows a 50kHz, 2nd-order, low-pass filter. The components have been selected to provide a maximally-flat Butterworth response. Beyond the cutoff frequency, roll-off is  $-40\text{dB/dec}$ . The Butterworth response is ideal for applications requiring predictable gain characteristics such as the anti-aliasing filter used ahead of an analog-to-digital converter (ADC).



**Figure 25. Second-Order Butterworth 50kHz Low-Pass Filter**

## DRIVING AN ANALOG-TO-DIGITAL CONVERTER

The low noise and wide gain bandwidth of the OPA377 family make it an ideal driver for ADCs. Figure 26 illustrates the OPA377 driving an ADS8327, 16-bit, 250kSPS converter. The amplifier is connected as a unity-gain, noninverting buffer.



(1) Suggested value; may require adjustment based on specific application.

(2) Initial calibration recommended.

**Figure 26. Driving an ADS8327<sup>(2)</sup>**

## REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (October 2010) to Revision B                                                | Page |
|-----------------------------------------------------------------------------------------------------|------|
| • Changed document status to production data .....                                                  | 1    |
| • Deleted cross-reference to note 2 and shading from DCK package in Package Information table ..... | 2    |
| • Updated <a href="#">Figure 22</a> .....                                                           | 9    |

| Changes from Original (February 2010) to Revision A                                                                | Page |
|--------------------------------------------------------------------------------------------------------------------|------|
| • Deleted DFN from list of packages in final <i>Features</i> bullet .....                                          | 1    |
| • Deleted DFN package from <i>Description</i> section .....                                                        | 1    |
| • Updated <i>Input Bias Current vs Temperature</i> plot .....                                                      | 1    |
| • Deleted cross-reference to note 2 and shading from all packages except SC70-5 in Package Information table ..... | 2    |
| • Deleted DFN-8 package from Package Information table .....                                                       | 2    |
| • Deleted Temperature Range, <i>DFN-8</i> parameter from Electrical Characteristics table .....                    | 3    |
| • Deleted DFN-8 pin configuration .....                                                                            | 4    |
| • Updated <a href="#">Figure 11</a> .....                                                                          | 6    |

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">OPA2377AID</a>     | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | O2377A              |
| OPA2377AID.B                   | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | O2377A              |
| <a href="#">OPA2377AIDGKR</a>  | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| OPA2377AIDGKR.B                | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| OPA2377AIDGKRG4                | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| OPA2377AIDGKRG4.B              | Active        | Production           | VSSOP (DGK)   8  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| <a href="#">OPA2377AIDGKT</a>  | Active        | Production           | VSSOP (DGK)   8  | 250   SMALL T&R       | Yes         | NIPDAU   NIPDAUAG                    | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| OPA2377AIDGKT.B                | Active        | Production           | VSSOP (DGK)   8  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OTAQ                |
| <a href="#">OPA2377AIDR</a>    | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | O2377A              |
| OPA2377AIDR.B                  | Active        | Production           | SOIC (D)   8     | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | O2377A              |
| <a href="#">OPA377AID</a>      | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| OPA377AID.A                    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| OPA377AID.B                    | Active        | Production           | SOIC (D)   8     | 75   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| <a href="#">OPA377AIDBVR</a>   | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVR.A                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVR.B                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVRG4                 | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVRG4.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVRG4.B               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| <a href="#">OPA377AIDBVT</a>   | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVT.A                 | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| OPA377AIDBVT.B                 | Active        | Production           | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAG                 |
| <a href="#">OPA377AIDCKR</a>   | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| OPA377AIDCKR.A                 | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | SN                                   | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| OPA377AIDCKR.B                 | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | SN                                   | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| <a href="#">OPA377AIDCKRG4</a> | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| OPA377AIDCKRG4.A               | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| OPA377AIDCKRG4.B               | Active        | Production           | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| <a href="#">OPA377AIDCKT</a>   | Active        | Production           | SC70 (DCK)   5   | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| OPA377AIDCKT.A               | Active        | Production           | SC70 (DCK)   5  | 250   SMALL T&R       | Yes         | SN                                   | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| OPA377AIDCKT.B               | Active        | Production           | SC70 (DCK)   5  | 250   SMALL T&R       | Yes         | SN                                   | Level-2-260C-1 YEAR               | -40 to 125   | PAF                 |
| <a href="#">OPA377AIDR</a>   | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| OPA377AIDR.A                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| OPA377AIDR.B                 | Active        | Production           | SOIC (D)   8    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP377A              |
| <a href="#">OPA4377AIPW</a>  | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP4377A             |
| OPA4377AIPW.A                | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP4377A             |
| <a href="#">OPA4377AIPWR</a> | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP4377A             |
| OPA4377AIPWR.A               | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | OP4377A             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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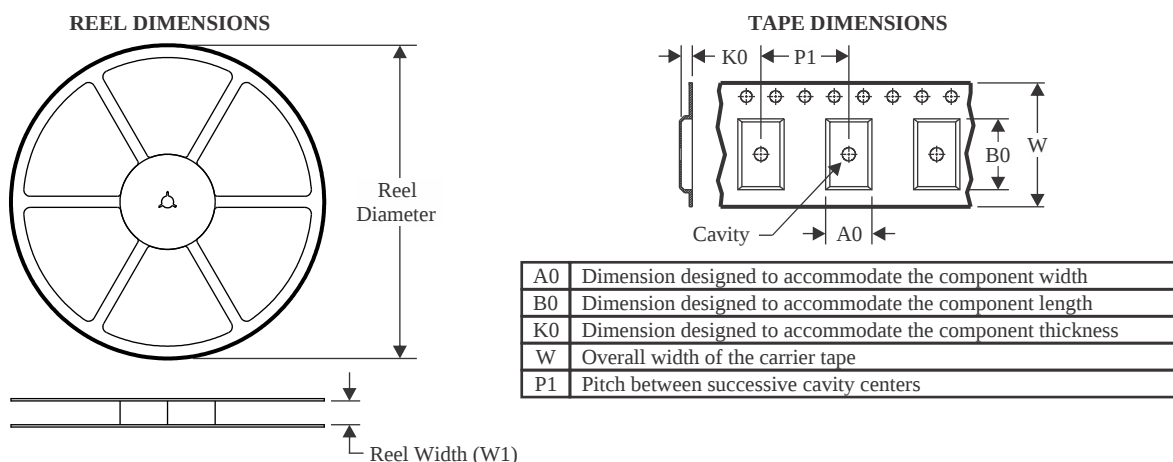
**OTHER QUALIFIED VERSIONS OF OPA2377, OPA377, OPA4377 :**

- Automotive : [OPA2377-Q1](#), [OPA377-Q1](#), [OPA4377-Q1](#)

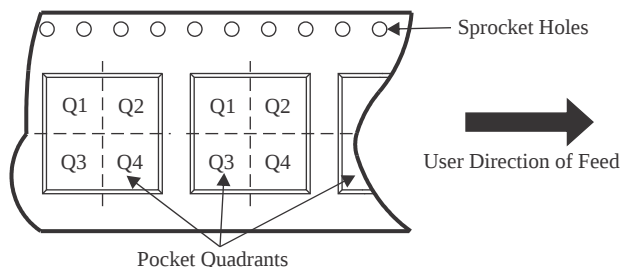
NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| OPA2377AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| OPA2377AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| OPA2377AIDGKT   | VSSOP        | DGK             | 8    | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| OPA2377AIDR     | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| OPA377AIDBVR    | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| OPA377AIDBVR    | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| OPA377AIDBVRG4  | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| OPA377AIDBVT    | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| OPA377AIDBVT    | SOT-23       | DBV             | 5    | 250  | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| OPA377AIDCKR    | SC70         | DCK             | 5    | 3000 | 179.0              | 8.4                | 2.2     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| OPA377AIDCKRG4  | SC70         | DCK             | 5    | 3000 | 179.0              | 8.4                | 2.2     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| OPA377AIDCKT    | SC70         | DCK             | 5    | 250  | 179.0              | 8.4                | 2.2     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| OPA377AIDR      | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| OPA4377AIPWR    | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| OPA2377AIDGKR   | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| OPA2377AIDGKRG4 | VSSOP        | DGK             | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| OPA2377AIDGKT   | VSSOP        | DGK             | 8    | 250  | 213.0       | 191.0      | 35.0        |
| OPA2377AIDR     | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| OPA377AIDBVR    | SOT-23       | DBV             | 5    | 3000 | 223.0       | 270.0      | 35.0        |
| OPA377AIDBVR    | SOT-23       | DBV             | 5    | 3000 | 213.0       | 191.0      | 35.0        |
| OPA377AIDBVRG4  | SOT-23       | DBV             | 5    | 3000 | 223.0       | 270.0      | 35.0        |
| OPA377AIDBVT    | SOT-23       | DBV             | 5    | 250  | 223.0       | 270.0      | 35.0        |
| OPA377AIDBVT    | SOT-23       | DBV             | 5    | 250  | 213.0       | 191.0      | 35.0        |
| OPA377AIDCKR    | SC70         | DCK             | 5    | 3000 | 213.0       | 191.0      | 35.0        |
| OPA377AIDCKRG4  | SC70         | DCK             | 5    | 3000 | 213.0       | 191.0      | 35.0        |
| OPA377AIDCKT    | SC70         | DCK             | 5    | 250  | 213.0       | 191.0      | 35.0        |
| OPA377AIDR      | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| OPA4377AIPWR    | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |

## TUBE



\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| OPA2377AID    | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| OPA2377AID.B  | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| OPA377AID     | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| OPA377AID.A   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| OPA377AID.B   | D            | SOIC         | 8    | 75  | 506.6  | 8      | 3940   | 4.32   |
| OPA4377AIPW   | PW           | TSSOP        | 14   | 90  | 508    | 8.5    | 3250   | 2.8    |
| OPA4377AIPW.A | PW           | TSSOP        | 14   | 90  | 508    | 8.5    | 3250   | 2.8    |



# EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



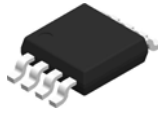
SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

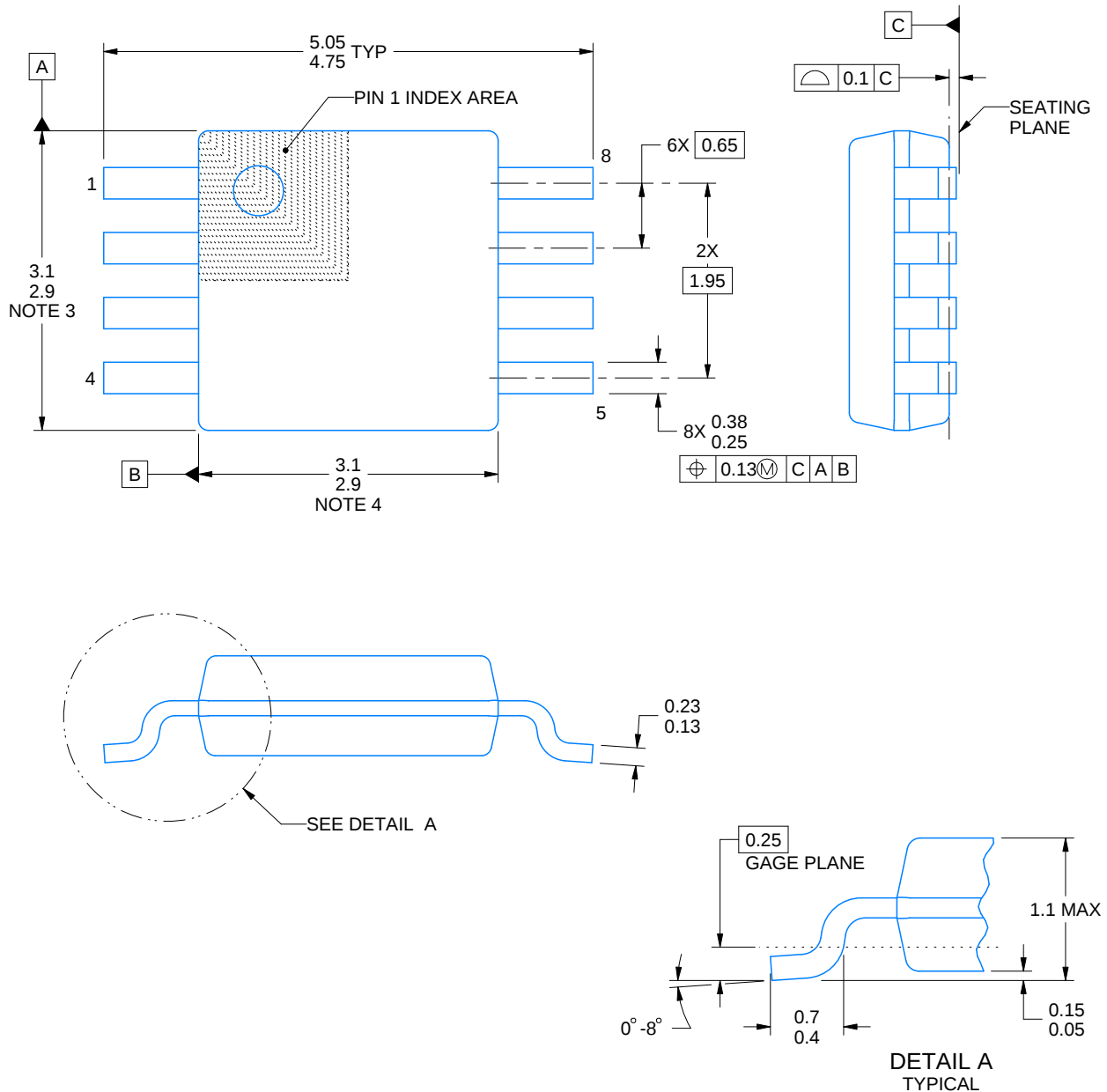
DGK0008A



# PACKAGE OUTLINE

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



4214862/A 04/2023

## NOTES:

PowerPAD is a trademark of Texas Instruments.

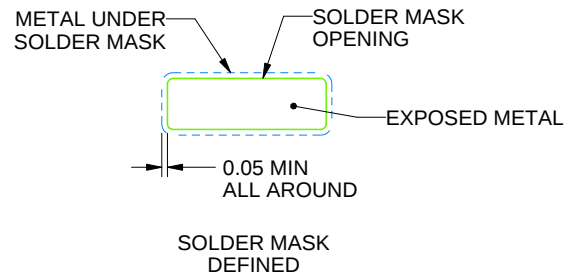
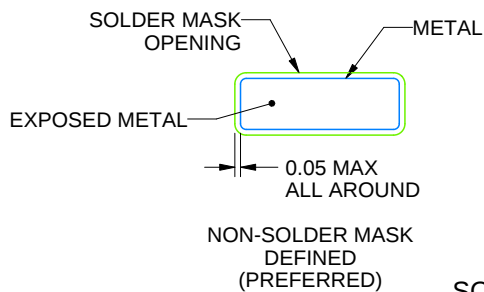
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187.

# EXAMPLE BOARD LAYOUT

DGK0008A

<sup>TM</sup> VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER MASK DETAILS

4214862/A 04/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
9. Size of metal pad may vary due to creepage requirement.

## EXAMPLE STENCIL DESIGN

DGK0008A

<sup>TM</sup> VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
SCALE: 15X

4214862/A 04/2023

NOTES: (continued)

11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
12. Board assembly site may have different recommendations for stencil design.



### SOT - 1.1 max height

Technical drawing of a mechanical part showing three views: front, side, and top.

**Front View Dimensions:**

- Overall width: 2.4 (1.8)
- Overall height: 2.15 (1.85)
- Horizontal hole positions: 1.4 (1.1)
- Vertical hole positions: 1.3 (1.3)
- Hole sizes: 0.15 (0.1)
- Feature **NOTE 4** is indicated.
- Hatched area labeled **PIN 1 INDEX AREA**.

**Side View Dimensions:**

- Width: 1.1 MAX
- Thickness: 0.1
- Feature **C** is indicated.

**Top View Dimensions:**

- Width: 0.46 TYP
- Height: 0.22 TYP
- Feature **NOTE 5** is indicated.
- Feature **NOTE 4** is indicated.

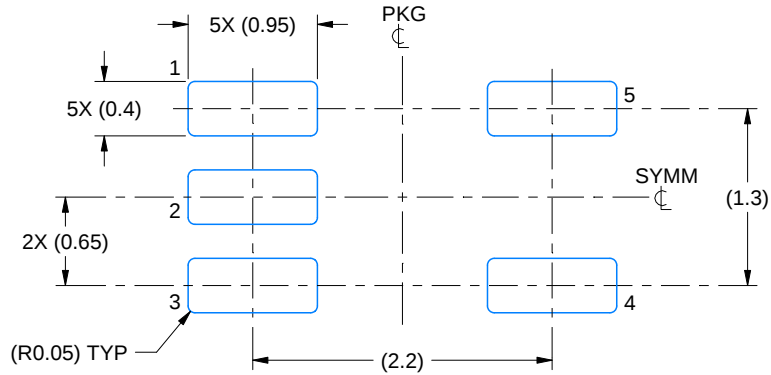
**Feature Control Frames:**

- $\phi$  0.1 M C A B (Circular runout)
- 0.1 C (Surface texture)

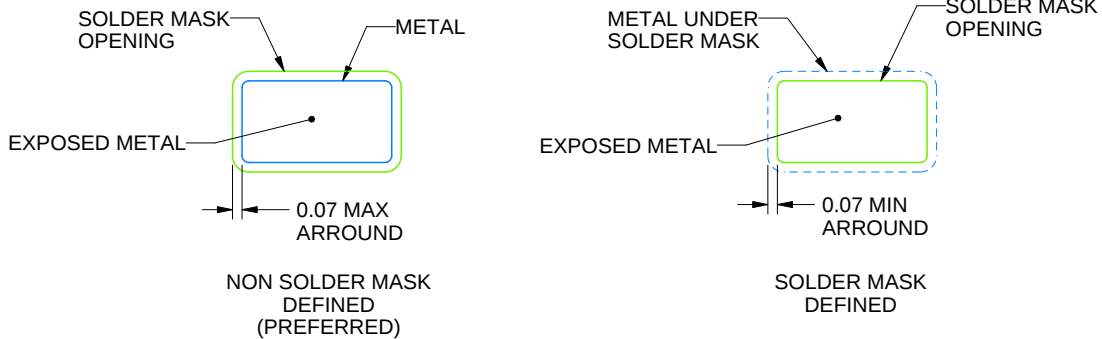
**Other Labels:**

- NOTE 4**: (0.15), (0.1)
- NOTE 5**: 5X 0.33 0.15
- SEATING PLANE**
- GAGE PLANE**
- 4X 4° -15°
- 8° 0° TYP
- 0.22 0.08 TYP
- 0.1 0.0 TYP

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X

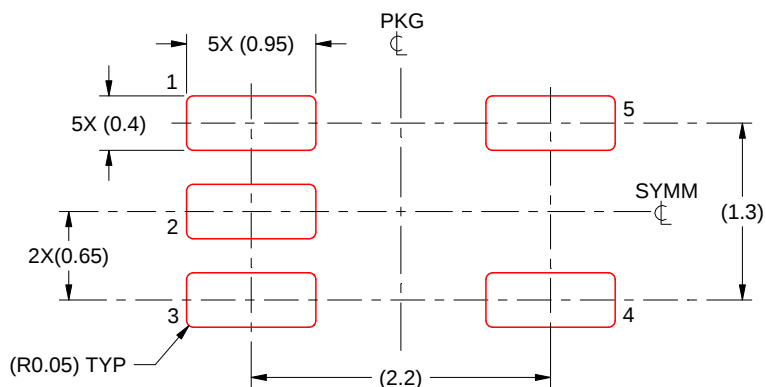


SOLDER MASK DETAILS

4214834/G 11/2024

NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 THICK STENCIL  
 SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.



## PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

**D0008A**

**SOIC - 1.75 mm max height**

## SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



## SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



4220202/B 12/2023

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220202/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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